

# STB70NF3LL

# N-channel 30V - 0.0075Ω - 70A - D<sup>2</sup>PAK Low gate charge STripFET™ II Power MOSFET

## **General features**

| Туре       | V <sub>DSS</sub> | R <sub>DS(on)</sub> | I <sub>D</sub> |
|------------|------------------|---------------------|----------------|
| STB70NF3LL | 30V              | < 0.0095Ω           | 70A            |

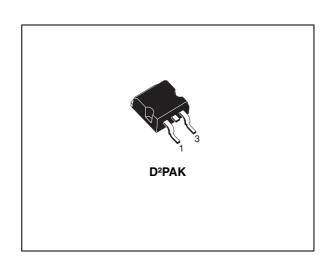
- Optimal R<sub>DS(on)</sub> x Qg trade-off @ 4.5V
- Conduction losses reduced
- Switching losses reduced

## **Description**

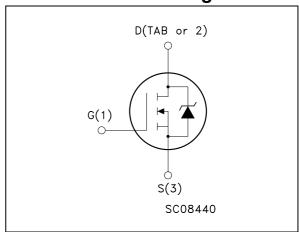
This application specific Power MOSFET is the third genaration of STMicroelectronis unique "Single Feature Size™" strip-based process. The resulting transistor shows the best trade-off between on-resistance and gate charge. When used as high and low side in buck regulators, it gives the best performance in terms of both conduction and switching losses. This is extremely important for motherboards where fast switching and high efficiency are of paramount importance.

# **Applications**

■ Switching application



## Internal schematic diagram



### **Order codes**

| Part number  | Part number Marking Package |                    | Packaging   |
|--------------|-----------------------------|--------------------|-------------|
| STB70NF3LLT4 | B70NF3LL@                   | D <sup>2</sup> PAK | Tape & reel |

Contents STB70NF3LL

# **Contents**

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STB70NF3LL Electrical ratings

# 1 Electrical ratings

Table 1. Absolute maximum ratings

| Symbol                         | Parameter                                            | Value      | Unit |  |
|--------------------------------|------------------------------------------------------|------------|------|--|
| V <sub>DS</sub>                | Drain-source voltage (V <sub>GS</sub> = 0)           | 30         | ٧    |  |
| V <sub>DGR</sub>               | Drain-gate voltage ( $R_{GS}$ = 20 kΩ)               | 30         | V    |  |
| V <sub>GS</sub>                | Gate- source voltage                                 | ± 16       | ٧    |  |
| I <sub>D</sub> <sup>(1)</sup>  | Drain current (continuous) at T <sub>C</sub> = 25°C  | 70         | Α    |  |
| I <sub>D</sub>                 | Drain current (continuous) at T <sub>C</sub> = 100°C | 50         | Α    |  |
| I <sub>DM</sub> <sup>(2)</sup> | Drain current (pulsed)                               | 280        | Α    |  |
| P <sub>TOT</sub>               | Total dissipation at T <sub>C</sub> = 25°C           | 100        | W    |  |
|                                | Derating factor                                      | 0.67       |      |  |
| dv/dt (3)                      | Peak diode recovery voltage slope                    | 5.5        | V/ns |  |
| E <sub>AS</sub> (4)            | Single pulse avalanche energy                        | 500        | mJ   |  |
| T <sub>stg</sub>               | Storage temperature                                  | -55 to 175 | °C   |  |
| TJ                             | Operating junction temperature                       | -55 to 175 |      |  |

<sup>1.</sup> Current limited by the package

Table 2. Thermal data

| Symbol            | Parameter                                      | Value | Unit |
|-------------------|------------------------------------------------|-------|------|
| R <sub>thJC</sub> | Thermal resistance junction-case Max           | 1.5   | °C/W |
| R <sub>thJA</sub> | Thermal resistance junction-ambient Max        | 62.5  | °C/W |
| T <sub>I</sub>    | Maximum lead temperature for soldering purpose | 300   | °C   |

<sup>2.</sup> Pulse width limited by safe operating area

<sup>4.</sup> Starting  $T_J = 25$  °C,  $I_D = 35A$ ,  $V_{DD} = 25V$ 

Electrical characteristics STB70NF3LL

# 2 Electrical characteristics

( $T_{CASE}$ =25°C unless otherwise specified)

Table 3. On/off states

| Symbol               | Parameter                                                | Test condit                                                       | Min                                      | Тур | Max             | Unit                     |        |
|----------------------|----------------------------------------------------------|-------------------------------------------------------------------|------------------------------------------|-----|-----------------|--------------------------|--------|
| V <sub>(BR)DSS</sub> | Drain-source<br>Breakdown voltage                        | $I_D = 250 \ \mu\text{A}, \ V_{GS} = 0$                           |                                          | 30  |                 |                          | V      |
| I <sub>DSS</sub>     | Zero gate voltage<br>Drain current (V <sub>GS</sub> = 0) | $V_{DS}$ = Max rating<br>$V_{DS}$ = Max rating<br>$T_{C}$ = 125°C |                                          |     | 1<br>10         | μ <b>Α</b><br>μ <b>Α</b> |        |
| I <sub>GSS</sub>     | Gate-body leakage<br>Current (V <sub>DS</sub> = 0)       | V <sub>GS</sub> = ± 16 V                                          |                                          |     |                 | ±100                     | nA     |
| V <sub>GS(th)</sub>  | Gate threshold voltage                                   | $V_{DS} = V_{GS}$                                                 | I <sub>D</sub> = 250μA                   | 1   |                 |                          | V      |
| R <sub>DS(on)</sub>  | Static drain-source on resistance                        | 40                                                                | <sub>D</sub> = 35A<br><sub>D</sub> = 18A |     | 0.0075<br>0.010 | 0.0095<br>0.012          | Ω<br>Ω |

Table 4. Dynamic

| Symbol                                                   | Parameter                                                         | Test conditions                    | Min | Тур                | Max | Unit           |
|----------------------------------------------------------|-------------------------------------------------------------------|------------------------------------|-----|--------------------|-----|----------------|
| 9 <sub>fs</sub>                                          | Forward<br>Transconductance                                       | $V_{DS} = 15V$ $I_D = 35A$         |     | 25                 |     | S              |
| C <sub>iss</sub><br>C <sub>oss</sub><br>C <sub>rss</sub> | Input capacitance Output capacitance Reverse transfer capacitance | $V_{DS} = 25V f = 1MHz V_{GS} = 0$ |     | 1650<br>540<br>130 |     | pF<br>pF<br>pF |

Table 5. Switching times

| Symbol                                            | Parameter                                                    | Test conditions                                                                                                                                                           | Min | Тур             | Max | Unit           |
|---------------------------------------------------|--------------------------------------------------------------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------|-----|-----------------|-----|----------------|
| t <sub>d(on)</sub><br>t <sub>r</sub>              | Turn-on delay time<br>Rise time                              | $V_{DD} = 15V$ $I_D = 35A$<br>$R_G = 4.7\Omega$ $V_{GS} = 4.5V$<br>(Resistive Load <i>Figure 16</i> )                                                                     |     | 23<br>165       |     | ns<br>ns       |
| $egin{array}{c} Q_{ m g} \ Q_{ m gd} \end{array}$ | Total gate charge<br>Gate-source charge<br>Gate-drain charge | V <sub>DD</sub> = 15V I <sub>D</sub> = 70A<br>V <sub>GS</sub> = 4.5V                                                                                                      |     | 24<br>8.5<br>12 | 33  | nC<br>nC<br>nC |
| t <sub>d(off)</sub><br>t <sub>f</sub>             | Turn-off delay time<br>Fall time                             | $\begin{array}{ccc} V_{DD} = 15 \text{ V} & I_D = 35 \text{ A} \\ R_G = 4.7 \Omega, & V_{GS} = 4.5 \text{ V} \\ \text{(Resistive Load } \textit{Figure 16} ) \end{array}$ |     | 27<br>28        |     | ns<br>ns       |

Table 6. Source drain diode

| Symbol                                                 | Parameter                                                                    | Test conditions                                                                                                                                   | Min | Тур             | Max       | Unit          |
|--------------------------------------------------------|------------------------------------------------------------------------------|---------------------------------------------------------------------------------------------------------------------------------------------------|-----|-----------------|-----------|---------------|
| I <sub>SD</sub>                                        | Source-drain current<br>Source-drain current<br>(pulsed)                     |                                                                                                                                                   |     |                 | 70<br>280 | A<br>A        |
| V <sub>SD</sub> <sup>(2)</sup>                         | Forward on voltage                                                           | $I_{SD} = 70 \text{ A}$ $V_{GS} = 0$                                                                                                              |     |                 | 1.3       | V             |
| t <sub>rr</sub><br>Q <sub>rr</sub><br>I <sub>RRM</sub> | Reverse recovery time<br>Reverse recovery charge<br>Reverse recovery current | $I_{SD} = 70 \text{ A di/dt} = 100 \text{A/µs}$<br>$V_{DD} = 20 \text{ V}$ $T_{J} = 150 ^{\circ}\text{C}$<br>(see test circuit <i>Figure 14</i> ) |     | 42<br>52<br>2.5 |           | ns<br>nC<br>A |

<sup>1.</sup> Pulse width limited by safe operating area.

<sup>2.</sup> Pulsed: Pulse duration = 300  $\mu$ s, duty cycle 1.5 %.

Electrical characteristics STB70NF3LL

# 2.1 Electrical characteristics (curves)

Figure 1. Safe operating area

Figure 2. Thermal impedance

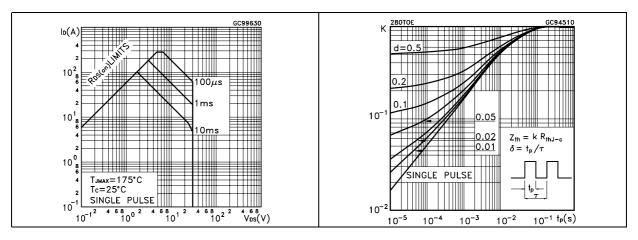


Figure 3. Output characterisics

Figure 4. Transfer characteristics

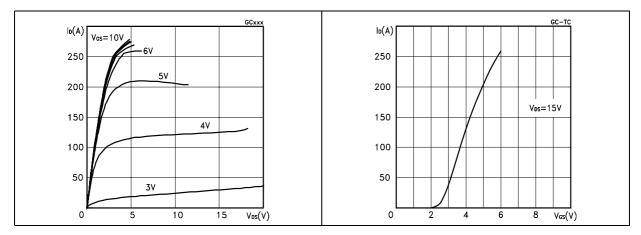
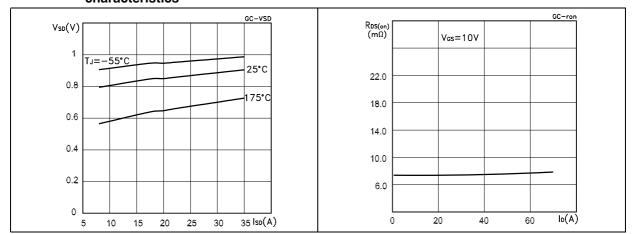


Figure 5. Source-drain diode forward characteristics

Figure 6. Static drain-source on resistance



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Gate charge vs gate-source voltage Figure 8. Capacitance variations

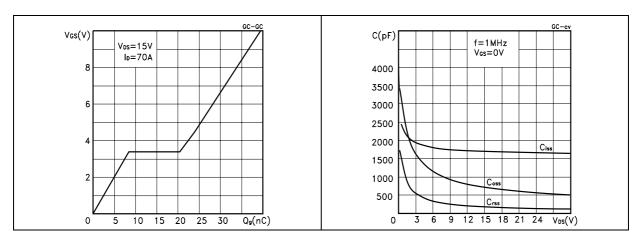


Figure 9. Normalized gate threshold voltage vs temperature

Figure 10. Normalized on resistance vs temperature Ros(on) (norm)  $V_{GS} = 10V$ lo=35A 1.6 1.4 1.2 1 0.8

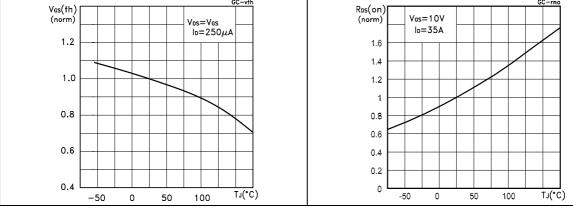
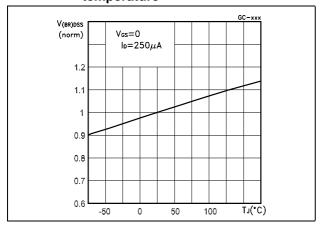


Figure 11. Normalized breakdown vs temperature



Test circuit STB70NF3LL

# 3 Test circuit

Figure 12. Switching times test circuit for resistive load

Figure 13. Gate charge test circuit

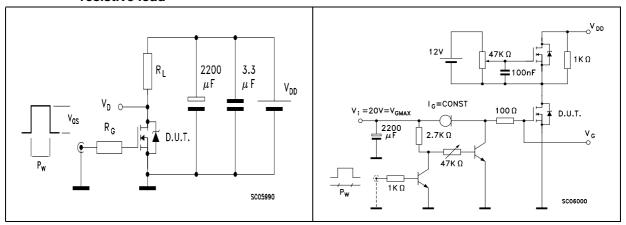


Figure 14. Test circuit for inductive load switching and diode recovery times

Figure 15. Unclamped Inductive load test circuit

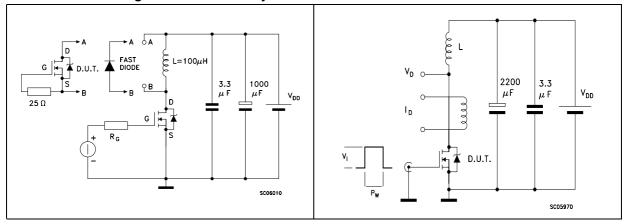
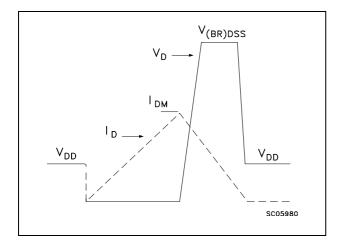


Figure 16. Unclamped inductive waveform



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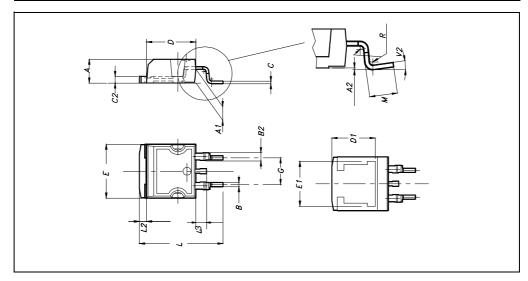
# 4 Package mechanical data

In order to meet environmental requirements, ST offers these devices in ECOPACK® packages. These packages have a Lead-free second level interconnect . The category of second level interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at: www.st.com

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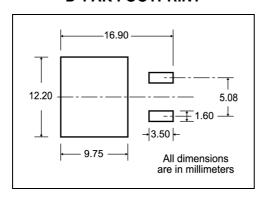
## D<sup>2</sup>PAK MECHANICAL DATA

| DIM  |                | mm. |       |       | inch  |       |
|------|----------------|-----|-------|-------|-------|-------|
| DIM. | MIN.           | TYP | MAX.  | MIN.  | TYP.  | MAX.  |
| Α    | 4.4            |     | 4.6   | 0.173 |       | 0.181 |
| A1   | 2.49           |     | 2.69  | 0.098 |       | 0.106 |
| A2   | 0.03           |     | 0.23  | 0.001 |       | 0.009 |
| В    | 0.7            |     | 0.93  | 0.027 |       | 0.036 |
| B2   | 1.14           |     | 1.7   | 0.044 |       | 0.067 |
| С    | 0.45           |     | 0.6   | 0.017 |       | 0.023 |
| C2   | 1.23           |     | 1.36  | 0.048 |       | 0.053 |
| D    | 8.95           |     | 9.35  | 0.352 |       | 0.368 |
| D1   |                | 8   |       |       | 0.315 |       |
| E    | 10             |     | 10.4  | 0.393 |       |       |
| E1   |                | 8.5 |       |       | 0.334 |       |
| G    | 4.88           |     | 5.28  | 0.192 |       | 0.208 |
| L    | 15             |     | 15.85 | 0.590 |       | 0.625 |
| L2   | 1.27           |     | 1.4   | 0.050 |       | 0.055 |
| L3   | 1.4            |     | 1.75  | 0.055 |       | 0.068 |
| М    | 2.4            |     | 3.2   | 0.094 |       | 0.126 |
| R    |                | 0.4 |       |       | 0.015 |       |
| V2   | 0 <sub>0</sub> |     | 4º    |       |       |       |

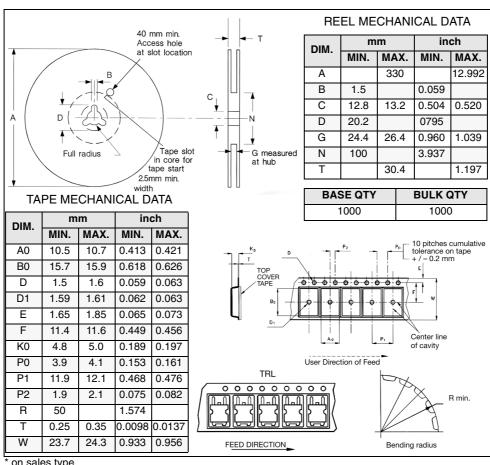


#### Packing mechanical data 5

## D<sup>2</sup>PAK FOOTPRINT



#### **TAPE AND REEL SHIPMENT**



Revision history STB70NF3LL

# 6 Revision history

Table 7. Revision history

| Date        | Revision | Changes                         |
|-------------|----------|---------------------------------|
| 21-Jun-2004 | 6        | Preliminary version             |
| 25-Jul-2006 | 7        | New template, no content change |

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## Contact Us:

## > Address:

401 Building No.5, JiuGe Business Center, Lane 2301, Yishan Rd Minhang District, Shanghai , China

## > Sales:

Direct +86 (21) 6401-6692

Email amall@ameya360.com

QQ 800077892

Skype ameyasales1 ameyasales2

## Customer Service :

Email service@ameya360.com

# Partnership :

Tel +86 (21) 64016692-8333

Email mkt@ameya360.com